### Label Table

<table>
<thead>
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<th>Variant</th>
<th>Label Text</th>
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<td>Changeki</td>
</tr>
<tr>
<td>332</td>
<td>Changeki</td>
</tr>
</tbody>
</table>

- **Assembly Note:**
  - This assembly is for PCB labels only.

### Assembly Note

- **Assembly Note:**
  - These assemblies are ESD sensitive; ESD precautions shall be observed.

- **Assembly Note:**
  - These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

- **Assembly Note:**
  - These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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